DATA SHEET

MOS FIELD EFFECT POWER TRANSISTORS 2SJ325, 2SJ325-Z

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SJ325 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

- Low On-state Resistance
 - $R_{DS(on)} = 83 \text{ m}\Omega \text{ TYP.} (V_{GS} = -10 \text{ V}, \text{ ID} = -2 \text{ A})$
 - RDS(on) = 0.15 Ω TYP. (VGs = -4 V, ID = -1.6 A)
- Low Ciss Ciss = 800 pF TYP.
- Built-in G-S Gate Protection Diode

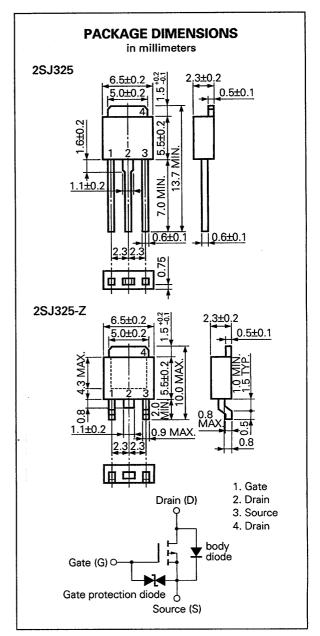
QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Drain to Source Voltage	VDSS	-30	۷
Gate to Source Voltage (AC)	Vgss	∓20	۷
Gate to Source Voltage (DC)	Vgss	-20, +10	V
Drain Current (DC)	ID(DC)	∓4.0	Α
Drain Current (pulse)	D(pulse)*	∓16	Α
Total Power Dissipation (Tc = 25 °C)	Ρτι	20	W
Total Power Dissipation (Ta = 25 °C)	Рт2	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
* PW \leq 10 μ s, Duty Cycle \leq 1 %			



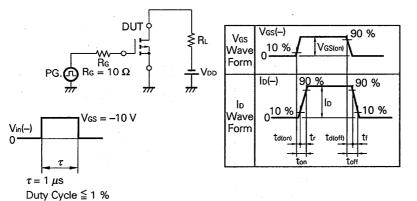
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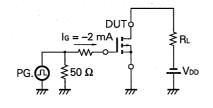
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		0.08	0.11	Ω	$V_{GS} = -10 V$, $I_D = -2.0 A$
Drain to Source On-state Resistance	RDS(on)		0.15	0.24	Ω	$V_{GS} = -4 V$, $I_D = -1.6 A$
Gate to Source Cutoff Voltage	VGS(off)	-1.0	-1.5	-2.0	v	V _{DS} = -10 V, I _D = -1 mA
Forward Transfer Admittance	yfs	3.0	4.2		S	$V_{DS} = -10 \text{ V}, \text{ ID} = -2.0 \text{ A}$
Drain Leakage Current	loss			-10	μA	$V_{DS} = -30 V, V_{GS} = 0$
Gate to Source Leakage Current	lgss			±10	μA	Vgs = ∓16 V, Vps = 0
Input Capacitance	Ciss		800		pF	V _{DS} = -10 V V _{GS} = 0 f = 1 MHz
Output Capacitance	Coss		600		pF	
Reverse Transfer Capacitance	Crss		250		pF	
Turn-On Delay Time	td(on)		15		ns	$ V_{GS(on)} = -10 V V_{DD} = -15 V I_D = -2.0 A, R_G = 10 Ω R_L = 7.5 Ω $
Rise Time	tr		65		ns	
Turn-Off Delay Time	td(off)		85		ns	
Fall Time	tr		60		ns	
Total Gate Charge	QG		28		nC	$V_{GS} = -10 V$ $I_D = -4.0 A$ $V_{DD} = -24 V$
Gate to Source Charge	Qgs		3		nC	
Gate to Drain Charge	QGD		11		nC	
Body Diode Forward Voltage	VF		0.9		V	IF = 4.0 A, VGS = 0
Reverse Recovery Time	trr		65		ns	l⊧ = 4.0 A, V _{GS} = 0 di/dt = 50 A/μs
Reverse Recovery Charge	Qrr		60		nC	

ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

Test Circuit 1: Switching Time

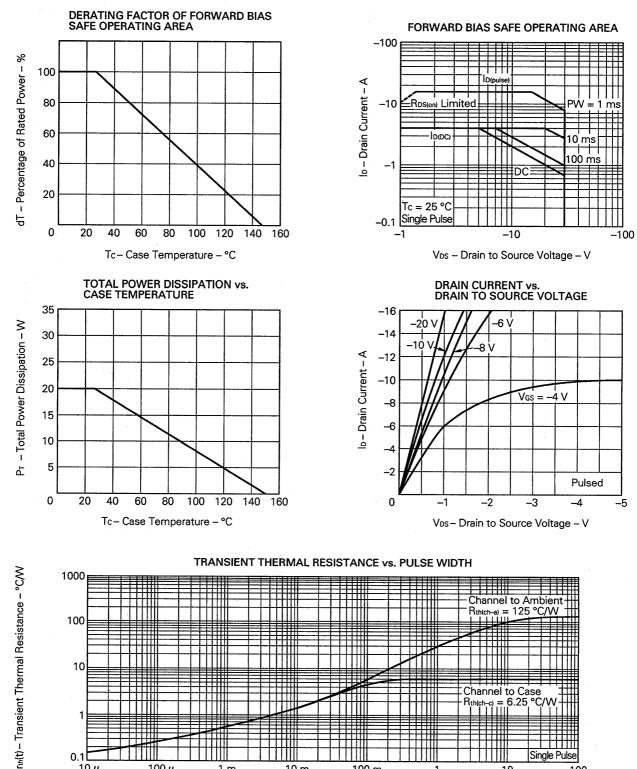


Test Circuit 2: Gate Charge



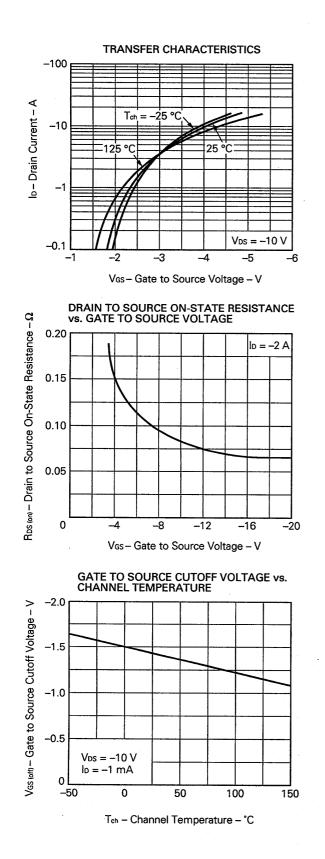
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TYPICAL CHARACTERISTICS (Ta = 25 °C)

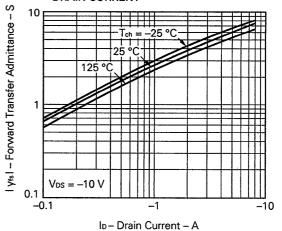


Channel to Ambient Rth(ch-a) = 125 °C/W ĦШ -+-++++ ╅╋ 100 **₹**₩₩ +# 1 10 Ħ Channel to Case +++FH $R_{th(ch-c)} = 6.25$ TIT 1 Single Pulse 0.1 10 µ $100 \, \mu$ 1 m 10 m 100 m 1 10 100 PW - Pulse Width - s

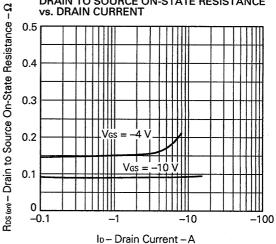
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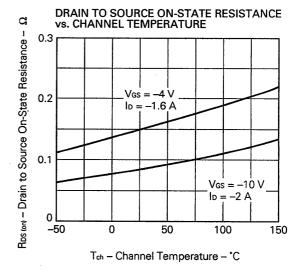


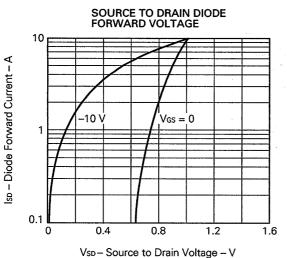
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



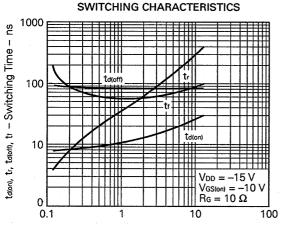




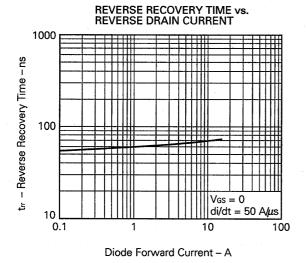


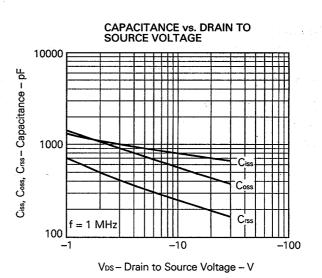


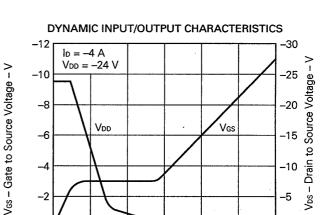




lo – Drain Current – A







Q₉ - Gate Charge - nC

Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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